

Title (en)  
Polishing apparatus.

Title (de)  
Poliergerät.

Title (fr)  
Appareil de polissage.

Publication  
**EP 0167679 A1 19860115 (EN)**

Application  
**EP 84201060 A 19840713**

Priority  
EP 84201060 A 19840713

Abstract (en)  
A polishing apparatus including a driving source (3), a polishing member (4) driven by the driving source (3), and a pair of guide members (23) and (30). The polishing member 4 is composed of a pair of rigid support plates (51) and (52) and an elastic body (50) sandwiched between the pair of rigid support plates (51) and (52). The lower-positioned support plate (52) is formed with a polishing face (5).

IPC 1-7  
**B24B 29/00**; **B24B 23/02**

IPC 8 full level  
**B24B 23/02** (2006.01); **B24D 9/08** (2006.01)

CPC (source: EP)  
**B24B 23/028** (2013.01); **B24D 9/08** (2013.01)

Citation (search report)

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